

Title (en)

CERAMIC MULTILAYERED COMPONENT AND METHOD FOR PRODUCING A CERAMIC MULTILAYERED COMPONENT

Title (de)

KERAMISCHES VIELSCHICHTBAUELEMENT UND VERFAHREN ZUR HERSTELLUNG EINES KERAMISCHEN VIELSCHICHTBAUELEMENTS

Title (fr)

ÉLÉMENT MULTICOUCHE EN CÉRAMIQUE ET PROCÉDÉ DE FABRICATION D'UN ÉLÉMENT MULTICOUCHE EN CÉRAMIQUE

Publication

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Application

**EP 11776771 A 20111027**

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Abstract (en)

[origin: WO2012059401A2] The invention relates to a ceramic multilayered component which comprises a layer stack (101) having a plurality of ceramic layers (102, 103, 104). The multilayered component comprises a first (105) and a second (106) connecting contact as well as a first (107) and a second (108) inner electrode which are each arranged between two layers (102, 103; 103, 104) of the layer stack (101). The multilayered component comprises a first (109) and a second (110) via electrode for electrically coupling the first connecting contact (105) to the first inner electrode (107) and for electrically coupling the second connecting contact (106) to the second inner electrode (108).

IPC 8 full level

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